

N-Channel 100-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{(BR)DSS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)		
100	0.100 at V _{GS} = 10 V	20		

FEATURES

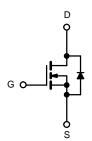
- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- Low Thermal Resistance Package
- 100 % R_g Tested

RoHS COMPLIANT

APPLICATIONS

• Isolated DC/DC Converters





N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _C = 25 °C, unless oth	erwise noted		
Parameter	Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	100	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \
Gate-Source Voltage	V _{GS}	± 20	V	
Continuous Drain Current (T _{.1} = 175 °C)	T _C = 25 °C	I-	20	
Continuous Diam Current (1) = 173 C)	T _C = 125 °C	I _D	16	A
Pulsed Drain Current	I _{DM}	70	7	
Avalanche Current L = 0.1 mH		I _{AS}	20	
Single Pulse Avalanche Energy ^b	L = 0.1 IIII1	E _{AS}	200	mJ
Mariana Barra Birata da h	T _C = 25 °C	В	105	10/
Maximum Power Dissipation ^b	T _A = 25 °C ^d	$ P_D$ $-$	3.75	W
Operating Junction and Storage Temperature Ra	T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Limit	Unit		
Junction-to-Ambient	PCB Mount (TO-263) ^d	R _{thJA}	40	°C/W		
Junction-to-Case (Drain)		R _{thJC}	0.4	C/VV		

Notes:

- a. Package limited.
- b. Duty cycle \leq 1 %.
- c. See SOA curve for voltage derating.
- d. When Mounted on 1" square PCB (FR-4 material).



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{DS} = 0 \text{ V}, I_{D} = 250 \mu\text{A}$	100			V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		3	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 100 V, V _{GS} = 0 V			1	μА	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 100 V, V _{GS} = 0 V, T _J = 125 °C			50		
		V _{DS} = 100 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	120			Α	
		V _{GS} = 10 V, I _D = 20 A		0.100			
Drain-Source On-State Resistance ^a	r _{DS(on)}	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.110		Ω	
		V _{GS} = 10 V, I _D = 20 A, T _J = 175 °C		0.120			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 20 A	25			S	
Dynamic ^b							
Input Capacitance	C _{iss}			950		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		280			
Reverse Transfer Capacitance	C _{rss}			110			
Total Gate Charge ^c	Qg				28		
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 100 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 65 \text{ A}$			4.8	nC	
Gate-Drain Charge ^c	Q_{gd}				15		
Gate Resistance	R _g		0.5	1.7	3.3	Ω	
Turn-On Delay Time ^c	t _{d(on)}			8			
Rise Time ^c	t _r	$V_{DD} = 100 \text{ V}, R_{L} = 1.5 \Omega$		120			
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 65 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		25		ns	
Fall Time ^c	t _f			50			
Source-Drain Diode Ratings and Cha	aracteristics 7	C _C = 25 °C ^b		•			
Continuous Current	Is				65		
Pulsed Current	I _{SM}				140	Α	
Forward Voltage ^a	V _{SD}	I _F = 65 A, V _{GS} = 0 V		1.0	1.5	V	
Reverse Recovery Time	t _{rr}			130	200	ns	
Peak Reverse Recovery Current	I _{RM(REC)}	I _F = 50 A, di/dt = 100 A/μs		8	12	Α	
Reverse Recovery Charge	Q _{rr}			0.52	1.2	uС	

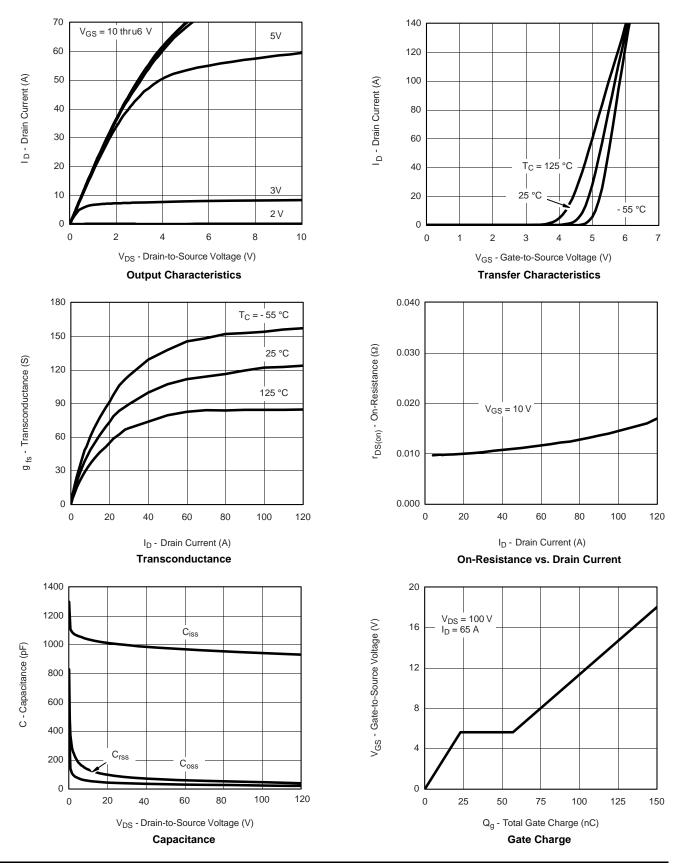
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

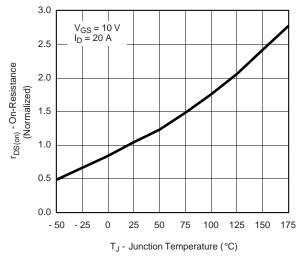


TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

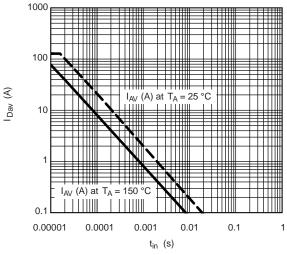




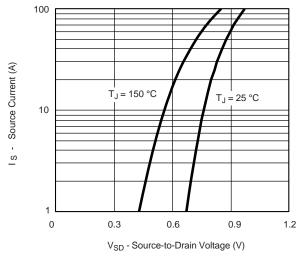
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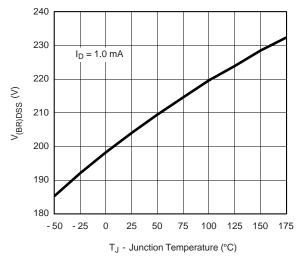
On-Resistance vs. Junction Temperature



Avalanche Current vs. Time



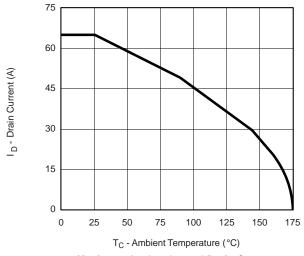
Source-Drain Diode Forward Voltage



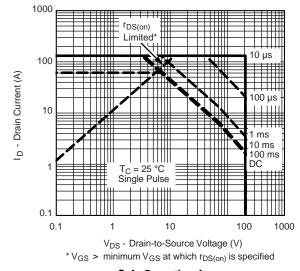
Drain Source Breakdown vs. Junction Temperature



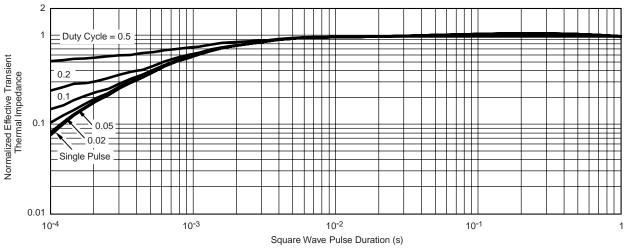
THERMAL RATINGS



Maximum Avalanche and Drain Current vs. Case Temperature



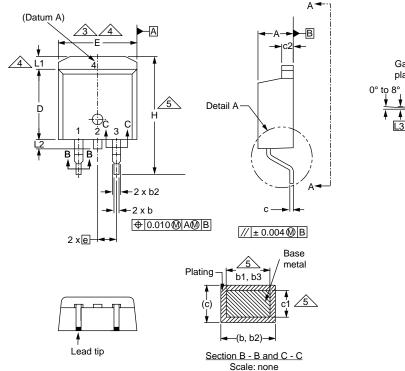
Safe Operating Area

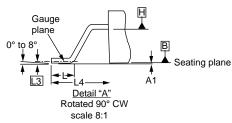


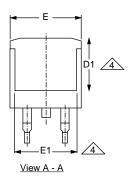
Normalized Thermal Transient Impedance, Junction-to-Case



TO-263AB (HIGH VOLTAGE)







	MILLIMETERS		INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

DIM. MIN. MAX. MIN. MAX. D1 6.86 - 0.270 - E 9.65 10.67 0.380 0.420 E1 6.22 - 0.245 - e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110 L1 - 1.65 - 0.066		MILLIN	METERS	INCHES	
E 9.65 10.67 0.380 0.420 E1 6.22 - 0.245 - e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110	DIM.	MIN.	MAX.	MIN.	MAX.
E1 6.22 - 0.245 - e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110	D1	6.86	-	0.270	-
e 2.54 BSC 0.100 BSC H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110	Е	9.65	10.67	0.380	0.420
H 14.61 15.88 0.575 0.625 L 1.78 2.79 0.070 0.110	E1	6.22	-	0.245	-
L 1.78 2.79 0.070 0.110	е	2.54 BSC		0.100	BSC
	Н	14.61	15.88	0.575	0.625
L1 - 1.65 - 0.066	L	1.78	2.79	0.070	0.110
	L1	-	1.65	-	0.066
L2 - 1.78 - 0.070	L2	-	1.78	-	0.070
L3 0.25 BSC 0.010 BSC	L3	0.25 BSC		0.010	BSC
L4 4.78 5.28 0.188 0.208	L4	4.78	5.28	0.188	0.208

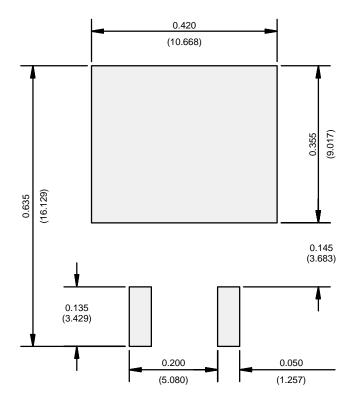
ECN: S-82110-Rev. A, 15-Sep-08

DWG: 5970

Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm) www.VBsemi.com

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